HCTL-2017 and HCTL-2021 Quadrature Decoder/Counter Interface ICs

Data Sheet



Description

The HCTL-2021/2017 is CMOS ICs that performs the quadrature decoder, counter, and bus interface function. The HCTL-2021/2017 is designed to improve system performance in digital closed loop motion control systems and digital data input systems. It does this by shifting time intensive quadrature decoder functions to a cost effective hardware solution. The HCTL-2021/2017 consists of a quadrature decoder logic, a binary up/down state counter, and an 8-bit bus interface. The use of Schmitt-triggered CMOS inputs and input noise filters allows reliable operation in noisy environments. The HCTL-2021/2017 contains 16-bit counter and provides TLL/CMOS compatible tri-state output buffers. Operation is specified for a temperature range from -40 to +85°C at clock frequencies up to 33MHz.

The HCTL-2021/2017 provides quadrature decoder output signals and cascade signals for use with many standard computer ICs.

The HCTL-2021/2017 is compliant to RoHS directive and had been declared as a lead free product.

Features

- Interfaces Encoder to Microprocessor
- 33 MHz Clock Operation
- High Noise Immunity: Schmitt Trigger Inputs and Digital Noise Filter
- 16-Bit Binary Up/Down Counter
- Latched Outputs
- 8-Bit Tristate Interface
- 8 or 16-Bit Operating Modes
- Quadrature Decoder Output Signals, Up/Down and Count
- Cascade Output Signals, Up/Down and Count
- Substantially Reduced System Software
- 5V Operation (VDD VSS)
- TTL/CMOS Compatible I/O
- Operating Temperature: -40°C to 85°C
- 16-pin and 20-Pin Launch Pad

Applications

- Interface Quadrature Incremental Encoders to Microprocessors
- Interface Digital Potentiometers to Digital Data Input Buses

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Part Number	Description	Pinout
HCTL-2017	33 MHz clock operation. 16-bit counter.	PINOUT A
HCTL-2021	33 MHz clock operation. 16-bit counter. Quadrature decoder output signals. Cascade output signals.	PINOUT B



1	DO	VDD	16	1	DO	VDD	20
2	CLK	D1	15	2	CLK	D1	19
				3	SEL	D2	18
3	SEL	D2	14	4	OE	D3	17
4	OE	D3	13	5	U/D	CNTdec	16
5	RST	D4	12	6	NC	CNTcas	15
6	CH B	D5	11	7	RST	D4	14
•		50		8	CH B	D5	13
7	CH A	D6	10	9	CH A	D6	12
8	VSS	D7	9	10	VSS	D7	11
	PINOU	IT A			PIN	DUT B	

Soldering and Mounting Considerations

It is recommended to use manual soldering for HCTL-2021/2017 launch pad devices due to the characteristics of the material used in the launch pad design that not allow wave soldering.

Direct mounting on printed circuit board (PCB) only is recommended for HCTL-2021/2017 launch pad devices.

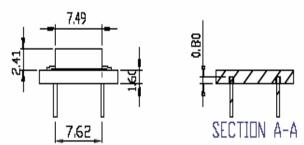
Mounting gap of 1mm between the base of the launch pad and customer's printed circuit board (PCB) is required.

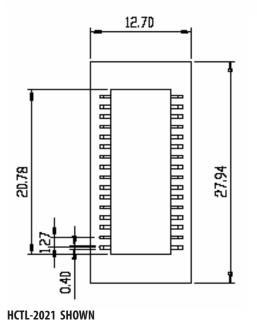
NOTE: Precaution is required in order to avoid bend or loose pin during product handling.

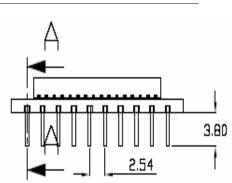
Package Dimensions with Tolerances

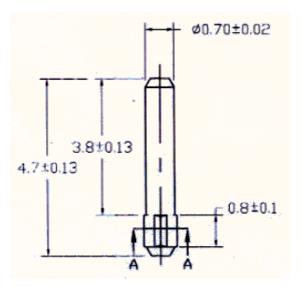
	Length (L)	Width (W)	Thickness (T)
HCTL-2017	22.86 ± 0.5 mm	12.70 ± 0.5 mm	1.67 ± 0.25 mm
HCTL-2021	27.94 ± 0.5 mm	12.70 ± 0.5 mm	1.67 ± 0.25 mm

(dimension in mm)









PIN DRAWING

Operating Characteristics

Table 1. Absolute Maximum Ratings

(All voltages below are referenced to VSS)

Parameter	Symbol	Limits	Units
DC Supply Voltage	V _{DD}	-0.3 to +6.0	V
Input Voltage	V _{IN}	-0.3 to (V _{DD} +0.3)	V
Storage Temperature	Ts	-40 to +100	°C
Operating Temperature [1]	T _A	-40 to +85	°C

Table 2. Recommended Operating Conditions

Parameter	Symbol	Limits	Units	
DC Supply Voltage	V _{DD}	4.5 to 5.5	V	
Ambient Temperature [1]	T _A	-40 to +85	°C	

Table 3. DC Characteristics VDD = 5V \pm 5%; TA = -40 to 85°C

Parameter	Condition	Min	Тур	Max	Unit
Low-Level Input Voltage				1.5	V
High-Level Input Voltage		3.5			V
Schmitt-Trigger Positive-Going Threshold			3.5	4.0	V
Schmitt-Trigger Negative-Going Threshold		1.0	1.5		V
Schmitt-Trigger Hysteresis		1.0	2.0		V
Input Current	$V_{\text{IN}}{=}V_{\text{SS}}$ or V_{DD}	-10	1	+10	μA
High-Level Output Voltage	I _{он} = -3.75 mA	2.4	4.5		V
Low-Level Output Voltage	I _{oL} = +3.75mA		0.2	0.4	V
High-Z Output Leakage Current	$V_0 = V_{SS}$ or V_{DD}	-10	1	+10	μA
Quiescent Supply Current	$V_{IN}=V_{ss}$ or V_{DD}		1	10	μA
Input Capacitance	Any Input		5		PF
Output Capacitance	Any Output		5		PF
	Low-Level Input Voltage High-Level Input Voltage Schmitt-Trigger Positive-Going Threshold Schmitt-Trigger Negative-Going Threshold Schmitt-Trigger Hysteresis Input Current High-Level Output Voltage Low-Level Output Voltage High-Z Output Leakage Current Ouiescent Supply Current Input Capacitance	Low-Level Input VoltageHigh-Level Input VoltageSchmitt-Trigger Positive-Going ThresholdSchmitt-Trigger Negative-Going ThresholdSchmitt-Trigger HysteresisInput Current $V_{IN}=V_{SS}$ or V_{DD} High-Level Output Voltage $I_{OH} = -3.75$ mALow-Level Output Voltage $I_{OL} = +3.75$ mAHigh-Z Output Leakage Current $V_{IN}=V_{SS}$ or V_{DD} Quiescent Supply Current $V_{IN}=V_{ss}$ or V_{DD} Input CapacitanceAny Input	Low-Level Input Voltage3.5High-Level Input Voltage3.5Schmitt-Trigger Positive-Going Threshold1.0Schmitt-Trigger Negative-Going Threshold1.0Schmitt-Trigger Hysteresis1.0Input Current $V_{IN}=V_{SS}$ or V_{DD} High-Level Output Voltage $I_{OH} = -3.75$ mALow-Level Output Voltage $I_{OL} = +3.75$ mAHigh-Z Output Leakage Current $V_0=V_{SS}$ or V_{DD} Ouiescent Supply Current $V_{IN}=V_{ss}$ or V_{DD} Input CapacitanceAny Input	Low-Level Input Voltage3.5High-Level Input Voltage 3.5 Schmitt-Trigger Positive-Going Threshold 3.5 Schmitt-Trigger Negative-Going Threshold 1.0 Schmitt-Trigger Negative-Going Threshold 1.0 Schmitt-Trigger Hysteresis 1.0 Input Current $V_{IN}=V_{SS}$ or V_{DD} Input Current $V_{IN}=-3.75$ mAHigh-Level Output Voltage $I_{OL} = +3.75$ mALow-Level Output Voltage $I_{OL} = +3.75$ mAUuescent Supply Current $V_{IN}=V_{SS}$ or V_{DD} Input CapacitanceAny InputSchrift CapacitanceSchrift Capacitance	Low-Level Input Voltage1.5High-Level Input Voltage 3.5 Schmitt-Trigger Positive-Going Threshold 3.5 Schmitt-Trigger Negative-Going Threshold 1.0 Schmitt-Trigger Hysteresis 1.0 Input Current $V_{IN}=V_{SS}$ or V_{DD} High-Level Output Voltage $I_{OH} = -3.75$ mALow-Level Output Voltage $I_{OL} = +3.75$ mALow-Level Output Voltage $I_{OL} = +3.75$ mAUnput Current $V_{IN}=V_{SS}$ or V_{DD} High-Z Output Leakage Current $V_{O}=V_{SS}$ or V_{DD} Ouiescent Supply Current $V_{IN}=V_{ss}$ or V_{DD} Input CapacitanceAny InputSolution <td< td=""></td<>

Notes:

1. Free Air

2. In general, for any VDD between the allowable limits (+4.5V to +5.5V), VIL = 0.3VDD and VIH = 0.7VDD; typical values are VOH = VDD – 0.5V and VOL = VSS + 0.2V

3. Including package capacitance but excluding PCB capacitance.

Functional Pin Description

Table 4. Functional Pin Descriptions

	I	Pin	
Symbol	HCTL-2017	HCTL-2021	 Description
V _{DD}	16	20	Power Supply
V _{ss}	8	10	Ground
CLK	2	2	CLK is a Schmitt-trigger input for the external clock signal.
CHA CHB	7 6	9 8	CHA and CHB are Schmitt-trigger inputs that accept the outputs from a quadrature-encoded source, such as incremental optical shaft encoder. Two channels, A and B, nominally 90 degrees out of phase, are required.
RST	5	7	This active low Schmitt-trigger input clears the internal position counter and the position latch. It also resets the inhibit logic. RST is asynchronous with respect to any other input signals.
OE	4	4	This CMOS active low input enables the tri-state output buffers. The OE/ and SEL inputs are sampled by the internal inhibit logic on the falling edge of the clock to control the loading of the internal position data latch.
SEL	3	3	These CMOS inputs directly controls which data byte from the position latch is enabled into the 8-bit tri-state output buffer. As in OE/ above, SEL also control the internal inhibit logic.
			SEL BYTE SELECTED
			0 High
			1 Low
	NA	16	A pulse is presented on this LSTTL-compatible output when the quadrature decoder has detected a state transition. CNT
U/D	NA	5	This LSTTL-compatible output allows the user to determine whether the IC is counting up or down and is intended to be used with the CNT_{DCDR} and CNT_{CAS} outputs. The proper signal U (high level) or D/ (low level) will be present before the rising edge of the CNT_{DCDR} and CNT_{CAS} outputs.
CNT _{CAS}	NA	15	A pulse is presented on this LSTTL-compatible output when the HCTL-2021 internal counter overflows or underflows. The rising edge on this waveform may be used to trigger an external counter.
D0	1	1	These LSTTL-compatible tri-state outputs form an 8-bit output ports through
D1	15	19	which the contents of the 16-bit position latch may be read in 2 sequential — bytes. The High byte is read first followed by the Low bytes.
D2	14	18	— bytes. The fligh byte is read hist followed by the Low bytes.
D3	13	17	_
D4	12	14	_
D5	11	13	
D6	10	12	
D7	9	11	_
NC	NA	6	Not connected - this pin should be left floating.

Switching Characteristics

Sym	bol Descr	iption	Min.	Max.	Units
1	t _{clk}	Clock Period	30		ns
2	t _{chh}	Pulse width, clock high	15		ns
3	t_{cD}	Delay time, rising edge of clock to valid, updated count information on D0-7		31	ns
4	t _{ode}	Delay time, OE fall to valid data		29	ns
5	t _{odz}	Delay time, OE rise to Hi-Z state on D0-7		29	ns
6	t_{SDV}	Delay time, SEL valid to stable, selected data byte (delay to High Byte = delay to Low Byte)		29	ns
7	t _{clH}	Pulse width, clock low	15		ns
8	t _{ss}	Setup time, SEL before clock fall	12		ns
9	t _{os}	Setup time, OEN before clock fall	12		ns
10	t _{sH}	Hold time, SEL after clock fall	0		ns
11	t _{он}	Hold time, OE after clock fall	0		ns
12	t _{RST}	Pulse width, RST low	10		ns
13	t _{udd}	Delay time, U/D valid after clock rise	4	29	ns
14	t _{chd}	Delay time, CNT_{DCDR} or CNT_{CAS} high after clock rise	4	31	ns
15	t _{cld}	Delay time, CNT _{DCDR} or CNT _{CAS} low after clock fall	4	31	ns

Table 5. Switching Characteristics Max/Min specifications at VDD = 5.0 ? 5%, TA = -40 to +85 OC, CL = 40 pf

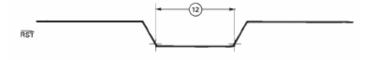
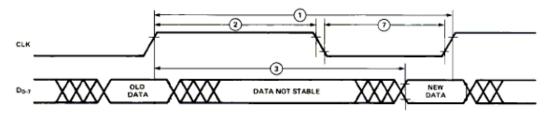
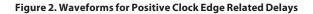


Figure 1. Reset Waveform





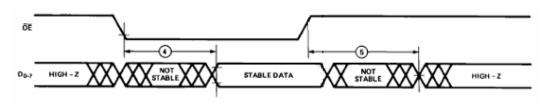


Figure 3. Tri-State Output Timing

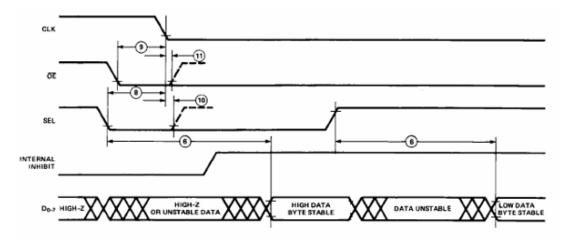


Figure 4. Bus Control Timing

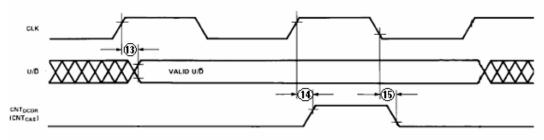
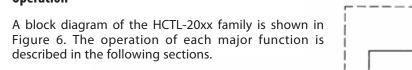
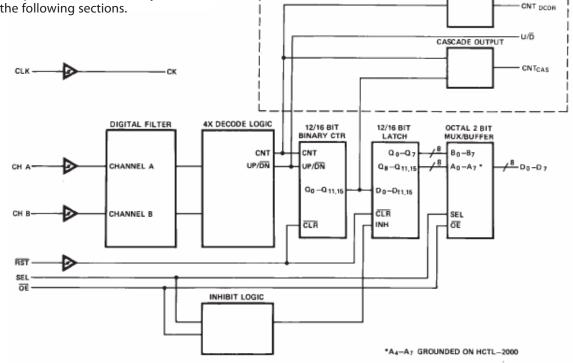


Figure 5. Decoder, Cascade Output Timing

Operation





HCTL-2020 ONLY

DECODE OUTPUT

Figure 6. Simplified Logic Diagram

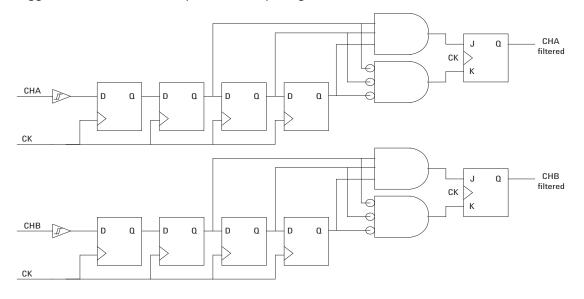
Digital Noise Filter

The digital noise filter section is responsible for rejecting noise on the incoming quadrature signals. The input section uses two techniques to implement improved noise rejection. Schmitt-trigger inputs and a three-clockcycle delay filter combine to reject low level noise and large, short duration noise spikes that typically occur in motor system applications. Both common mode and differential mode noise are rejected. The user benefits from these techniques by improved integrity of the data in the counter. False counts triggered by noise are avoided.

Figure 7 shows the simplified schematic of the input section. The signals are first passed through a Schmitt-trigger buffer to address the problem of input signals

with slow rise times and low-level noise (approximately < 1V). The cleaned up signals are then passed to a fourbit delay filter. The signals on each channel are sampled on rising clock edges. A time history of the signals is stored in the four-bit shift register. Any change on the input is tested for a stable level being present for three consecutive rising clock edges. Therefore, the filtered output waveforms can change only after an input level has the same value for three consecutive rising clock edges.

Refer to Figure 8, which shows the timing diagram. The result of this circuitry is that short noise spikes between rising clock edges are ignored and pulses shorter than two clock periods are rejected.





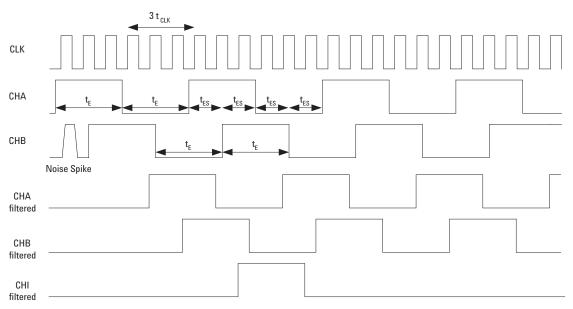


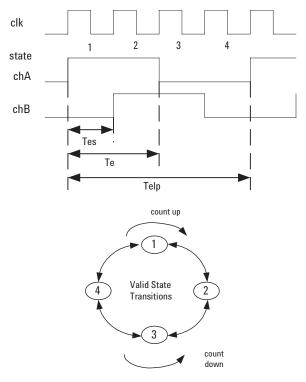
Figure 8. Signal Propagation through Digital Noise Filter

Quadrature Decoder

The quadrature decoder decodes the incoming filtered signals into count information. This circuitry multiplies the resolution of the input signals by a factor of four (4X decoding).

The quadrature decoder samples the outputs of the CHA and CHB filters. Based on the past binary state of the two signals and the present state, it outputs a count signal and a direction signal to the integral position counter.

Figure 9 shows the quadrature states of Channel A and Channel B signals. The 4x decoder will output a count signal for every state transition (count up and count down). Figure 9 shows the valid state transitions for 4x decoder. The 4x decoder will output a count signal at respective state transition, depending on the counting direction. Channel A leading channel B results in counting up. Channel B leading channel A results in counting down. Illegal state transitions, caused by faulty encoders or noise severe enough to pass through the filter, will produce an erroneous count.



CHA	СНВ	STATE	4X Decoder (Count Up & Count Down)
1	0	1	Pulse
1	1	2	Pulse
0	1	3	Pulse
0	0	4	Pulse

Figure 9. 4x Decoder Mode

Design Considerations

The designer should be aware that the operation of the digital filter places a timing constraint on the relationship between incoming guadrature signals and the external clock. Figure 8 shows the timing waveform with an incremental encoder input. Since an input has to be stable for three rising clock edges, the encoder pulse width (t_E - low or high) has to be greater than three clock periods (3t_{CLK}). This guarantees that the asynchronous input will be stable during three consecutive rising clock edges. A realistic design also has to take into account finite rise time of the waveforms, asymmetry of the waveforms, and noise. In the presence of large amounts of noise, t_E should be much greater than 3t_{CLK} to allow for the interruption of the consecutive level sampling by the three-bit delay filter. It should be noted that a change on the inputs that is qualified by the filter will internally propagate in a maximum of seven clock periods.

The quadrature decoder circuitry imposes a second timing constraint between the external clock and the input signals. There must be at least one clock period between consecutive quadrature states. As shown in Figure 8, a quadrature state is defined by consecutive edges on both channels. Therefore, t_{ES} (encoder state period) > t_{CLK}. The designer must account for deviations from the nominal 90 degree phasing of input signals to guarantee that t_{ES} > t_{CLK}.

Position Counter

This section consists of a 16-bit binary up/down counter which counts on rising clock edges as explained in the Quadrature Decoder Section. All 16-bit of data are passed to the position data latch. The system can use this count data in several ways:

- A. System total range is $d \le 16$ bits, so the count represents "absolute" position.
- B. The system is cyclic with \leq 16 bits of count per cycle. RSTN (or CHI) is used to reset the counter every cycle and the system uses the data to interpolate within the cycle.
- C. System count is > 8 or 16 bits, so the count data is used as a relative or incremental position input for a system software computation of absolute position. In this case counter rollover occurs. In order to prevent loss of position information, the processor must read the outputs of the IC before the count increments one-half of the maximum count capability. Two's-complement arithmetic is normally used to compute position from these periodic position updates.
- D. The system count is >16 bits so the HCTL-2021/2017 can be cascaded with other standard counter ICs to give absolute position.

Position Data Latch

The position data latch is a 16-bit latch which captures the position counter output data on each rising clock edge, except when its inputs are disabled by the inhibit logic section during four-byte read operations. The output data is passed to the bus interface section. When active, a signal from the inhibit logic section prevents new data from being captured by the latch, keeping the data stable while successive reads are made through the bus section. The latch is automatically re-enabled at the end of these reads. The latch is cleared to 0 asynchronously by the RST signal.

Inhibit Logic

The Inhibit Logic Section samples the OE and SEL signals on the falling edge of the clock and, in response to certain conditions (see Figure 10), inhibits the position data latch. The RST signal asynchronously clears the inhibit logic, enabling the latch.

Bus Interface

The bus interface section consists of a 16 to 8 line multiplexer and an 8-bit, three-state output buffer. The multiplexer allows independent access to the low and high bytes of the position data latch. The SEL and OE signals determine which byte is output and whether or not the output bus is in the high-Z state.

Quadrature Decoder Output

The quadrature decoder output section consists of count and up/down outputs derived from the 4x decoder mode of the HCTL-2021/2017. When the decoder has detected a count, a pulse, one-half clock cycle long, will be output on the CNT_{DCDR} pin. This output will occur during the clock cycle in which the internal counter is updated. The U/D pin will be set to the proper voltage level one clock cycle before the rising edge of the CNT_{DCDR} pulse, and held one clock cycle after the rising edge of the CNT_{DCDR} pulse. These outputs are not affected by the inhibit logic.

Cascade Output

The cascade output also consists of count and up/down outputs. When the HCTL-2021/2017 internal counter overflows or underflows, a pulse, one-half clock cycle long, will be output on the CNT_{CAS} pin. This output will occur during the clock cycle in which the internal counter is updated. The U/D pin will be set to the proper voltage level one clock cycle before the rising edge of the CNT_{CAS} pulse, and held one clock cycle after the rising edge of the CNT_{CAS} pulse. These outputs are not affected by the inhibit logic.

Step	SEL	OE	CLK	Inhibit Signal	Action
1	L	L	Falling	1	Set inhibit; read high byte
2	Н	L	Falling	1	Read low byte; starts reset
3	Х	Н	Falling	0	Complete inhibit logic reset

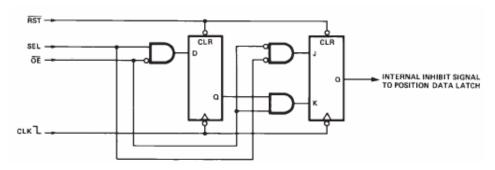




Figure 11. Simplified Inhibit Logic

Cascade Considerations

The HCTL-2021/2017 cascading system allows for position reads of more than four bytes. These reads can be accomplished by latching all the bytes and then reading the bytes sequentially over the 8-bit bus. It is assumed here that, externally, a counter followed by a latch is used to count any count that exceeds 16 bits. This configuration is compatible with the HCTL-2021/2017 internal counter/latch combination.

Consider the sequence of events for a read cycle that starts as the HCTL-2021/2017 internal counter rolls over. On the rising clock edge, count data is updated in the internal counter, rolling it over. A count-cascade pulse (CNT_{CAS}) will be generated with some delay after the rising clock edge (t_{CHD}). There will be additional propagation delays through the external counters and registers. Meanwhile, with SEL and OE low to start the read, the internal latches are inhibited at the falling edge and do not update again till the inhibit is reset.

If the CNT_{CAS} pulse now toggles the external counter and this count gets latched a major count error will

occur. The count error is because the external latches get updated when the internal latch is inhibited.

Valid data can be ensured by latching the external counter data when the high byte read is started (SEL and OE low). This latched external byte corresponds to the count in the inhibited internal latch. The cascade pulse that occurs during the clock cycle when the read begins gets counted by the external counter and is not lost.

For example, suppose the HCTL-2021/2017 count is at FFFFh and an external counter is at F0h, with the count going up. A count occurring in the HCTL-2021/2017 will cause the counter to roll over and a cascade pulse will be generated. A read starting on this clock cycle will show FFFFh from the HCTL-2021/2017. The external latch should read F0h, but if the host latches the count after the cascade signal propagates through, the external latch will read F1h.

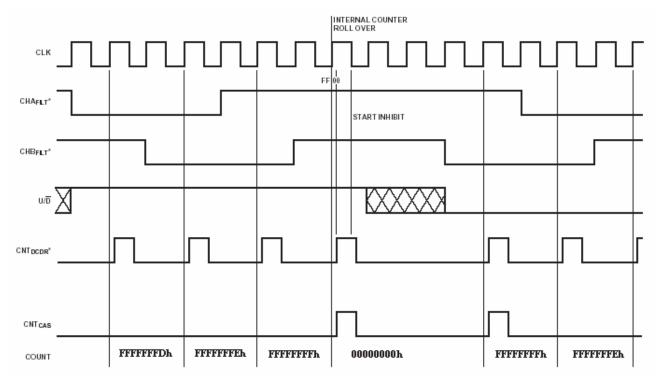


Figure 12. Decode and Cascade Output Diagram (4x)

General Interfacing

The 16-bit latch and inhibit logic allows access to 16 bits of count with an 8-bit bus. When only 8-bits of count are required, a simple 8-bit (1-byte) mode is available by holding SEL high continuously. This disables the inhibit logic. OE provides control of the tristate bus, and read timing is shown in Figure 2 and 3.

For proper operation of the inhibit logic during a twobyte read, OE and SEL must be synchronous with CLK due to the falling edge sampling of OE and SEL.

The internal inhibit logic on the HCTL-2021/2017 inhibits the transfer of data from the counter to the position data latch during the time that the latch outputs are being read. The inhibit logic allows the microprocessor / microcontroller to first read the high order 4 or 8 bits from the latch and then read the low order 8 bits from the latch. Meanwhile, the counter can continue to keep track of the quadrature states from the CHA and CHB input signals.

Figure 11 shows the simplified inhibit logic circuit. The operation of the circuitry is illustrated in the read timing shown in Figure 13.

Actions

- 1. On the rising edge of the clock, counter data is transferred to the position data latch, provided the inhibit signal is low.
- 2. When OE goes low, the outputs of the multiplexer are enabled onto the data lines. If SEL is low, then the high order data bytes are enabled onto the data lines. If SEL is high, then the low order data bytes are enabled onto the data lines.
- 3. When the IC detects a low on OE and SEL during a falling clock edge, the internal inhibit signal is activated. This blocks new data from being transferred from the counter to the position data latch.
- 4. When SEL goes high, the data outputs change from the high byte to the low byte.
- 5. The first of two reset conditions for the inhibit logic is met when the IC detects a logic high on SEL and a logic low on OE during a falling clock edge.
- 6. When OE goes high, the data lines change to a high impedance state.
- 7. The IC detects a logic high on OE during a falling clock edge. This satisfies the second reset condition for the inhibit logic.

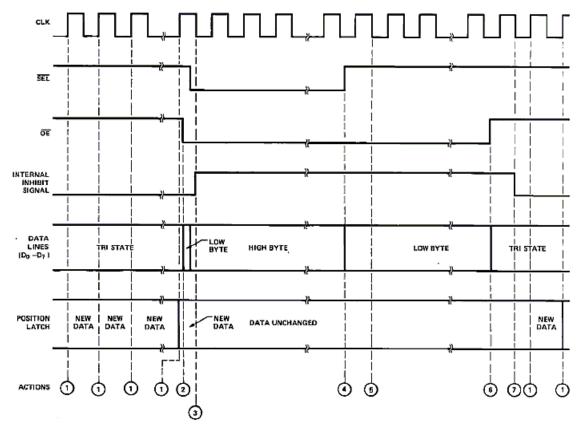


Figure 13. Typical Interface Timing

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